XP132A1545SR is Discontinued. XP132A1545SR

Power MOSFET

■GENERAL DESCRIPTION

The XP132A1545SR is a P-channel Power MOSFET with low on-state resistance and ultra high-speed switching characteristics.

Because high-speed switching is possible, the IC can be efficiently set thereby saving energy. The small SOP-8 package makes high density mounting possible.

APPLICATIONS

- Notebook PCs
- Cellular and portable phones
- On-board power supplies
- ●Li-ion battery systems

■FEATURES

Low On-State Resistance : Rds(on)=0.03 Ω (Vgs=-10V): Rds(on)=0.045 Ω (Vgs=-4.5V)Ultra High-Speed Switc-ImgDriving Voltage: -4.5VP-Channel Power MOSFETDMOS StructurePackage: SOP-8

PIN CONFIGURATION



(TOP VIEW)

■EQUIVALENT CIRCUIT



P-channel MOSFET (1 device built-in)

PIN ASSIGNMENT

PIN NUMBER	PIN NAME	FUNCTION
1~3	S	Source
4	G	Gate
5~8	D	Drain

■ABSOLUTE MAXIMUM RATINGS

Ta = 25						
PARAMETER	SYMBOL	RATINGS	UNITS			
Drain-Source Voltage	Vdss	-30	V			
Gate-Source Voltage	Vgss	±20	V			
Drain Current (DC)	ld	-8	А			
Drain Current (Pulse)	ldp	-32	А			
Reverse Drain Current	ldr	-8	А			
Channel Power Dissipation *	Pd	2.5	W			
Channel Temperature	Tch	150	°C			
Storage Temperature Range	Tstg	-55~150	°C			

* When implemented on a glass epoxy PCB

■ELECTRICAL CHARACTERISTICS

DC Characteristics

DC Characteristics					-	Ta = 25°C
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain Cut-Off Current	ldss	Vds=-30V, Vgs=0V	-	-	-10	μA
Gate-Source Leak Current	lgss	Vgs=±20V, Vds=0V	-	-	±1	μA
Gate-Source Cut-Off Voltage	Vgs(off)	ld=-1mA, Vds=-10V	-1.0	-	-2.5	V
Drain-Source On-State Resistance *	Rds(on)	Id=-4A, Vgs=-10V	-	0.025	0.030	Ω
		Id=-4A, Vgs=-4.5V	-	0.038	0.045	Ω
Forward Transfer Admittance *	Yfs	Id=-4A, Vds=-10V	-	11	-	S
Body Drain Diode Forward Voltage	Vf	lf=-8A, Vgs=0V	-	-0.85	-1.1	V

* Effective during pulse test.

Dynamic Characteristics

Dynamic CharacteristicsTa = 25°C						a = 25°C
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Capacitance	Ciss	Vds=-10V, Vgs=0V f=1MHz	-	1500	-	pF
Output Capacitance	Coss		-	1000	-	pF
Feedback Capacitance	Crss		-	500	-	pF

Switching Characteristics

Switching Characteristics $Ta = 25^{\circ}C$						
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-On Delay Time	td (on)	Vgs=-5V, Id=-4A Vdd=-10V	-	20	-	ns
Rise Time	tr		-	45	-	ns
Turn-Off Delay Time	td (off)		-	40	-	ns
Fall Time	tf		-	35	-	ns

Thermal Characteristics

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal Resistance (Channel-Ambience)	Rth (ch-a)	Implement on a glass epoxy resin PCB	-	50	-	°C/W

TYPICAL PERFORMANCE CHARACTERISTICS



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■TYPICAL PERFORMANCE CHARACTERISTICS (Cotinued)





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